- All Outputs Are High for Invalid Input Conditions
- Also for Application as
 4-Line-to-16-Line Decoders
 3-Line-to-8-Line Decoders
- Diode-Clamped Inputs

	TYPICAL	TYPICAL
TYPES	POWER	PROPAGATION
	DISSIPATION	DELAYS
'42A	140 mW	17 ns
'LS42	35 mW	17 ns

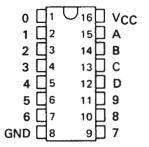
description

These monolithic BCD-to-decimal decoders consist of eight inverters and ten four-input NAND gates. The inverters are connected in pairs to make BCD input data available for decoding by the NAND gates. Full decoding of valid input logic ensures that all outputs remain off for all invalid input conditions.

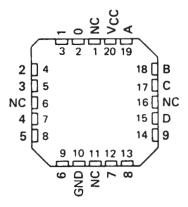
The '42A and 'LS42 feature inputs and outputs that are compatible for use with most TTL and other saturated low-level logic circuits. DC noise margins are typically one volt.

The SN5442A and SN54LS42 are characterized for operation over the full military temperature range of $-55\,^{\circ}\text{C}$ to $125\,^{\circ}\text{C}$. The SN7442A and SN74LS42 are characterized for operation from $0\,^{\circ}\text{C}$ to $70\,^{\circ}\text{C}$.

SN5442A, SN54LS42...J OR W PACKAGE SN7442A...N PACKAGE SN74LS42...D OR N PACKAGE (TOP VIEW)

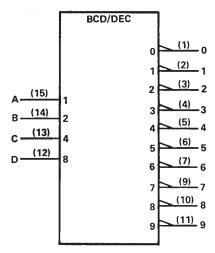


SN54LS42 . . . FK PACKAGE (TOP VIEW)



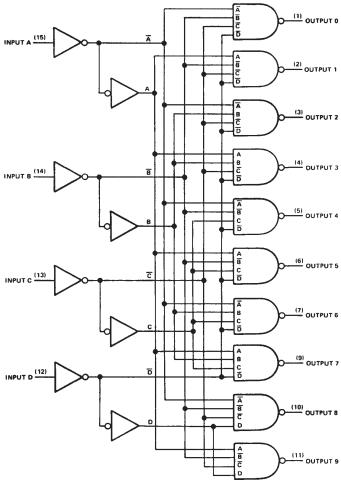
NC - No internal connection

logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

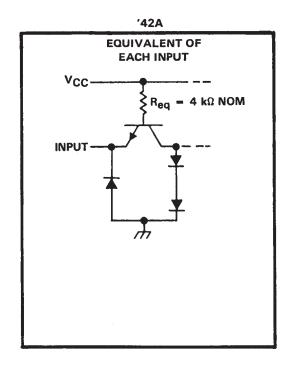
logic diagram (positive logic)

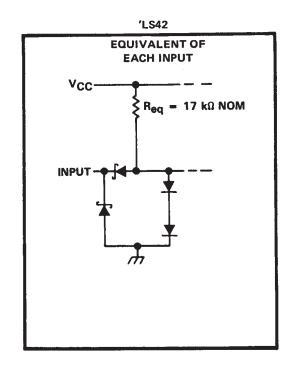


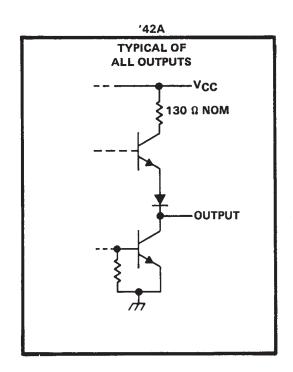
Pin numbers shown are for D, J, N, and W packages.

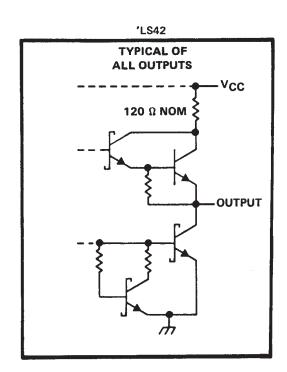


schematics of inputs and outputs









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FUNCTION TABLE

NO. BCI			NPUT					DECI	MAL (OUTPU	Т			
NO.	D	С	В	Α	0	1	2	3	4	5	6	7	8	9
0	L	L	L	L	L	Н	Н	Н	н	Н	Н	Н	Н	Н
1	L	L	L	н	Н	L	Н	н	Н	Н	Н	Н	Н	н
2	L	L	Н	L	н	Н	L	Н	Н	Н	Н	Н	Н	н
3	L	L	Н	н	н	Н	Н	L	Н	Н	Н	Н	Н	Н
4	L	Н	L	L	н	Н	Н	Н	L	Н	Н	Н	Н	Н
5	L	Н	L	Н	Н	Н	Н	Н	Н	L	Н	Н	Н	Н
6	L	Н	Н	L	н	Н	н	Н	Н	Н	L	Н	Н	Н
7	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	L	Н	Н
8	Н	L	L	L	Н	Н	Н	Н	Н	Н	Н	Н	L	Н
9	Н	L	L	Н	н	Н	Н	Н	Н	Н	Н	Н	Н	L
	Н	L	Н	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н
	н	L	Н	н	н	Н	Н	н	Н	Н	Н	Н	Н	Н
Į	н	Н	L	L	н	Н	Н	Н	Н	Н	Н	Н	Н	Н
INVALID	н	Н	L	Н	н	Н	н	Н	Н	Н	Н	Н	Н	Н
=	н	Н	Н	L	н	Н	н	н	Н	Н	н	н	Н	Н
	Н	Н	Н	Н	н	Н	. H	Н	Н	<u>H</u>	Н	Н	Н	H

H = high level, L = low level

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)	٧
Input voltage: '42A	٧
'LS42 7	V
Operating free-air temperature range: SN5442A, SN54LS42	Ċ
SN7442A, SN74LS42 0°C to 70°	C
Storage temperature range	Ċ

NOTE 1: Voltage values are with respect to network ground terminal.



recommended operating conditions

		SN5442A			SN7442A			
	MIN	NOM	MAX	MIN	NOM	MAX		
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5.25	V	
High-level output current, IOH			-800			800	μΑ	
Low-level output current, IOL			16			16	mA	
Operating free-air temperature, TA	-55		125	0		70	°C	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS [†]		SN5442A			SN7442A			
			MIN	TYP‡	MAX	MIN	TYP‡	MAX		
VIH	High-level input voltage		2			2			٧	
VIL	Low-level input voltage				0.8			8.0	V	
VIK	Input clamp voltage	V _{CC} = MIN, I _I = -12 mA			-1.5			-1.5	V	
Vон	High-level output voltage	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = 0.8 V, I _{OH} = -800 μA	2.4	3.4		2.4	3.4		٧	
VOL	Low-level output voltage	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = 0.8 V, I _{OL} = 16 mA		0.2	0.4		0.2	0.4	٧	
l ₁	Input current at maximum input voltage	V _{CC} = MAX, V _I = 5.5 V			1			1	mA	
ЧН	High-level input current	V _{CC} = MAX, V ₁ = 2.4 V			40			40	μΑ	
HL	Low level input current	V _{CC} = MAX, V _I = 0.4 V			-1.6			-1.6	mA	
Ios	Short-circuit output current §	V _{CC} = MAX	-20		-55	-18		-55	mA	
Icc	Supply current	V _{CC} = MAX, See Note 2		28	41		28	56	mA	

For conditions shown as MIN or MAX, use the appropriate values specified under recommended operating conditions.

NOTE 2: I_{CC} is measured with all outputs open and all inputs grounded.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ} \text{ C}$

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
^t PHL	Propagation delay time, high-to-low-level output from A, B, C, or D through 2 levels of logic			14	25	ns
tPHL	Propagation delay time, high-to-low-level output from A, B, C, or D through 3 levels of logic	C _L = 15 pF, R ₁ = 400 Ω,		17	30	ns
tPLH	Propagation delay time, low-to-high-level output from A, B, C, and D through 2 levels of logic	See Note 3		10	25	ns
tPLH	Propagation delay time, low-to-high-level output from A, B, C, and D through 3 levels of logic			17	30	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



 $^{^{\}ddagger}$ All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

 $[\]S$ Not more than one output should be shorted at a time.

SN5442A, SN54LS42, SN7442A, SN74LS42 **4-LINE BCD TO 10-LINE DECIMAL DECODERS**

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recommended operating conditions

	S	N54LS4	12	S	UNIT		
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5.25	٧
High-level output current, IOH			-400			-400	μΑ
Low-level output current, IOL			4			8	mA
Operating free-air temperature, TA	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER		CT CONDITIO	anct.	st SN54LS42		12	S			
	PARAWETER	1 E	TEST CONDITIONS [†]			TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIH	High-level input voltage				2			2			V
VIL	Low-level input voltage						0.7			0.8	V
VIK	Input clamp voltage	V _{CC} = MIN,	I _J = -18 mA				-1.5			-1.5	V
Voн	High-level output voltage	V _{CC} = MIN, V _{IL} = V _{IL} max,	V _{IH} = 2 V, I _{OH} = -400	μΑ	2.5	3.5		2.7	3.5		v
V-0.	Low-level output voltage	V _{CC} = MIN,	V _{IH} = 2 V,	I _{OL} = 4 mA		0.25	0.4		0.25	0.4	\ ,
VOL		V _I L = V _I L max		1 _{OL} = 8 mA					0.35	0.5	
П	Input current at maximum input voltage	V _{CC} = MAX,	V _I = 7 V				0.1			0.1	mA
ΉΗ	High-level input current	V _{CC} = MAX,	V ₁ = 2.7 V		T		20			20	μА
IL	Low-level input current	V _{CC} = MAX,	V _I = 0.4 V				-0.4			-0.4	mA
los	Short-circuit output current §	V _{CC} = MAX			-20		-100	-20		-100	mA
Icc	Supply current	V _{CC} = MAX,	See Note 2			7	13		7	13	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Propagation delay time, high-to-low-level				15	25	ns
THE	output from A, B, C, or D through 2 levels of logic			15		""
+0	Propagation delay time, high-to-low-level	C: - 15 mE		20	30	
tPH L	output from A, B, C, or D through 3 levels of logic	$C_L = 15 pF$		20	30	ns
* D	Propagation delay time, low-to-high-level	R _L = 2 kΩ, See Note 3		45	25	
†PLH	output from A, B, C, and D through 2 levels of logic	See Note 3		15	25	ns
t n	Propagation delay time, low-to-high-level				30	
tPLH	output from A, B, C, and D through 3 levels of logic			20	30	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



 $[\]ddagger$ All typical values are at V_{CC} = 5 V, T_{Δ} = 25°C. § Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTE 2. I_{CC} is measured with all outputs open and inputs grounded.

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